

Product Details for 322 - HCS5P3 - 300



DIP Sockets

[RoHS/Not ELV Compliant](#) ([Find RoHS Compliant Alternates/Compliance Statement](#))

Product Highlights:

- ? DIP Socket
- ? Number of Positions = 1
- ? Row-to-Row Spacing = 7.62 mm
- ? Thru Hole
- ? Mount Style = Vertical

[View all Features](#)

322 - HCS5P3 - 300

Tyco Part Number: 3 - 1437514 - 7

[Active](#)

Quick Links

- [Check Pricing & Availability](#)
- [Search for Tooling](#)
- [Product Feature Selector](#)
- [Contact Us About This Product](#)

Documentation & Additional Information

Product Drawings:

- ? [None Available](#)

Catalog Pages/Data Sheets:

- ? [None Available](#)

Product Specifications:

- ? [AUGAT* HOLTITE* Sockets](#) (PDF, English)

Application Specifications:

- ? [AUGAT HOLTITE Sockets](#) (PDF, English)

Instruction Sheets:

- ? [None Available](#)

CAD Files:

- ? [None Available](#)

Additional Information:

- ? [Product Line Information](#)

Related Products:

- ? [Tooling](#)

[List all Documents](#)

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- ? [Product Type](#) = DIP Socket
- ? [Number of Positions](#) = 1
- ? [Profile](#) = Zero
- ? [Frame Style](#) = Film Carrier
- ? [Leg Style](#) = Straight
- ? Proprietary Name = HOLTITE
- ? Sleeve Finish = Tin -Lead

Electrical Characteristics:

- ? Contact Resistance (m?) = 10
- ? Contact Rating = 3A

Termination Related Features:

- ? [Termination Post Length \(mm \[in\]\)](#) = 3.18 [0.125]

Body Related Features:

- ? [Row-to-Row Spacing \(mm \[in\]\)](#) = 7.62 [0.300]
- ? [Mount Style](#) = Vertical
- ? [Centerline \(mm \[in\]\)](#) = 2.54 [0.100]

Contact Related Features:

- ? [Contact Mount](#) = Thru Hole
- ? [Contact Material](#) = Beryllium Copper
- ? [Contact Mating Area Plating](#) = Tin -Lead
- ? [Contact Style](#) = Screw Machine
- ? [Mating Contact Type](#) = Four -Fingered

Housing Related Features:

- ? [Number of Patterns Per Reel](#) = 1
- ? Carrier Strip Material = Mylar

Configuration Related Features:

- ? [Height Above PC Board \(mm \[in\]\)](#) = 0.00 [0.000]

Industry Standards:

- ? [RoHS/ELV Compliance](#) = RoHS/Not ELV Compliant
- ? [Lead Free Solder Processes](#) = Not relevant for lead free process
- ? RoHS/ELV Compliance History = Always was RoHS not ELV compliant

Conditions for Usage:

- ? Temperature Range (°C) = -55 - +105

Packaging Related Features:

- ? [Packaging Method](#) = Reel
- ? Packaging Quantity = 5,000

Other:

- ? Brand = AMP